NSN 5962-01-341-0830

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View Online at https://aerobasegroup.com/nsn/5962-01-341-0830

Overall Height:
0.432 inches
Body Length:
1.490 inches
Body Width:
Between 0.500 inches and 0.610 inches
Body Height:
Between 0.172 inches and 0.217 inches
Maximum Power Dissipation Rating:
1.0 watts
Operating Tempurature Range:
-55.0/+125.0 degrees celsius
Storage Tempurature Range:
-65.0/+150.0 degrees celsius
Features Provided:
Hermetically sealed and burn in and ultraviolet erasable and w/enable and programmable and electrostatic sensitive
Inclosure Material:
Ceramic
Inclosure Configuration:
Dual-in-line
Output Logic Form:
N-type metal oxide-semiconductor logic
Input Circuit Pattern:
25 input
Case Outline Source And Designator:
D-10 mil-m-38510
Current Rating Per Characteristic:
125.00 milliamperes reverse current, dc absolute
Terminal Surface Treatment:
Solder
Voltage Rating And Type Per Characteristic:
-0.6 volts power source and 6.25 volts power source
Capitance Rating Per Characteristic:
Err-060 and err-060
Time Rating Per Chacteristic:
250.00 nanoseconds access
Memory Device Type:
Eprom
Unpackaged Unit Weight:
7.5 grams

Test Data Document:

96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.).

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	Ī	erminal	Type	And	Quantit	y:
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28 printed circuit

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

Yes - demil/mli

Fiig:

A458a0